



DMN1001UCA10

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

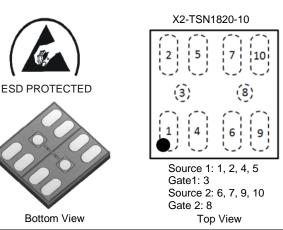
BVsss	Rss(on) Typ	ls Max T₄ = +25°C	
12V	$3.36m\Omega @ V_{GS} = 3.8V$	20A	

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{SS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Battery Management
- Load Switch
- Battery Protection

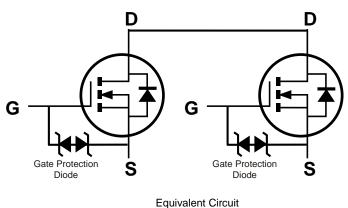


Features

- CSP with Footprint 1.84mm × 1.96mm
- Height = 0.30mm (Typical) for Low Profile
- ESD Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: X2-TSN1820-10
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiAu. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0026 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1001UCA10-7	X2-TSN1820-10	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

M7 YM	

M7 = Product Type Marking Code

- YM = Date Code Marking
- Y = Year (ex: G = 2019)
- M = Month (ex: 9 = September)

Date Code Key												
Year	2019	2020	2	021	2022	202	3	2024	2025	20	26	2027
Code	G	Н		1	J	K		L	М	1	N	0
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit			
Source-Source Voltage	V _{SSS}	12	V			
Gate-Source Voltage	Vgss	±8	V			
	Steady	T _A = +25°C		20	•	
Continuous Source Current (Note 5) $V_{GS} = 4.5V$	State	T _A = +70°C	Is	16	A	
		14.5				
Continuous Source Current (Note 5) V _{GS} = 2.5V	Is	11.5	А			
Pulsed Source Current (Note 6)	I _{SM}	90	А			

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	1.0	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 7)	Reja	125	°C/W
Power Dissipation (Note 5)	PD	2.4	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	R _{0JA}	52	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

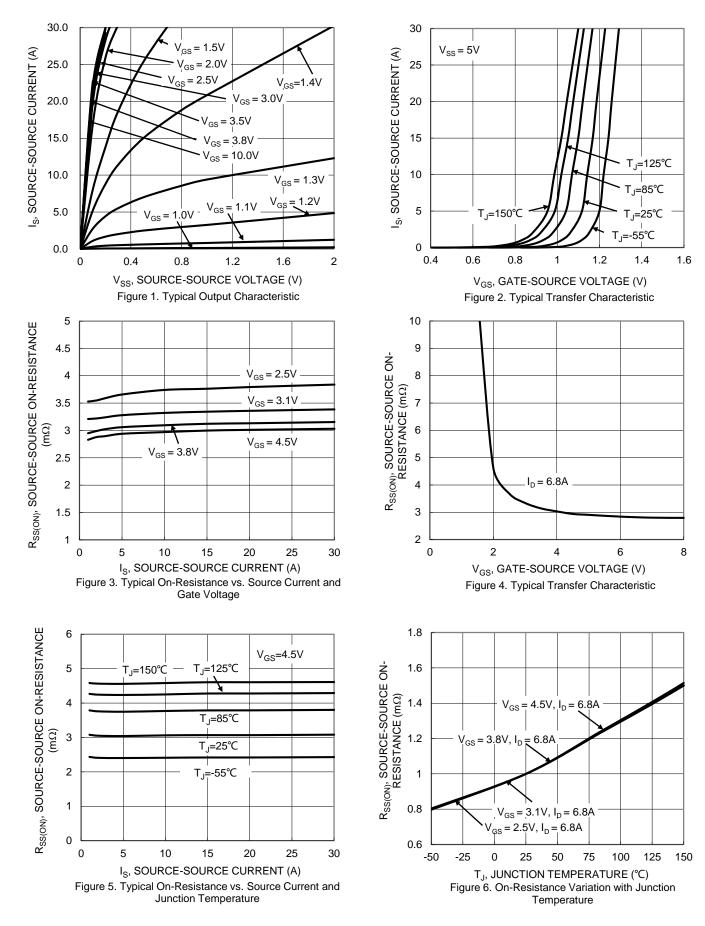
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)			71	1	•	
Source -Source Breakdown Voltage	BVsss	12	_	_	V	$V_{GS} = 0V$, $I_{S} = 1mA$
Zero Gate Voltage Drain Current TJ = +25°C	lsss	—	_	1	μA	$V_{SS} = 10V V_{GS} = 0V$
Gate-Source Leakage	lgss	—		±10	μA	$V_{GS} = \pm 8V, V_{SS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	0.35	_	1.4	V	$V_{SS} = 10V$, $I_{S} = 0.87mA$
		1.9	3.19	3.55		V _{GS} = 4.5V, I _S = 5A
Static Source-Source On-Resistance		2.0	3.36	3.75		Vgs = 3.8V, Is = 5A
Static Source-Source On-Resistance	R _{SS(ON)}	2.25	3.69	4.8	mΩ	Vgs = 3.1V, Is = 5A
		2.5	4.38	6.9		Vgs = 2.5V, Is = 5A
Diode Forward Voltage	V _{SS}	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 6.8A$
DYNAMIC CHARACTERISTICS (Note 9)	•					·
Input Capacitance	Ciss	—	2865	—	pF	
Output Capacitance	Coss	—	500	—		$V_{SS} = 6V, V_{GS} = 0V,$ f = 1.0kHz
Reverse Transfer Capacitance	Crss	—	247			1 = 1.0KHZ
Gate Resistance	Rg	—	375		Ω	$V_{GS} = 0V$, $V_{DS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg	—	29	_		
Gate-Source Charge	Qgs	_	5.0	_		$V_{DD} = 6V, V_{GS} = 4V,$
Gate-Drain Charge	Qgd	—	9.6	—	nC	Is = 6.8A
Gate Charge at Vтн	Qg(TH)	_	5.2	_		
Turn-On Delay Time	t _{D(ON)}	—	508	—		
Turn-On Rise Time	tR	—	1034	—	1	$V_{DD} = 6V, V_{GS} = 4V,$
Turn-Off Delay Time	tD(OFF)	—	1395	_	ns	$I_{\rm S} = 6.8 {\rm A}$
Turn-Off Fall Time	tF	—	2074	_	1	

Notes:

Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
Repetitive rating, pulse width limited by junction temperature.
Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

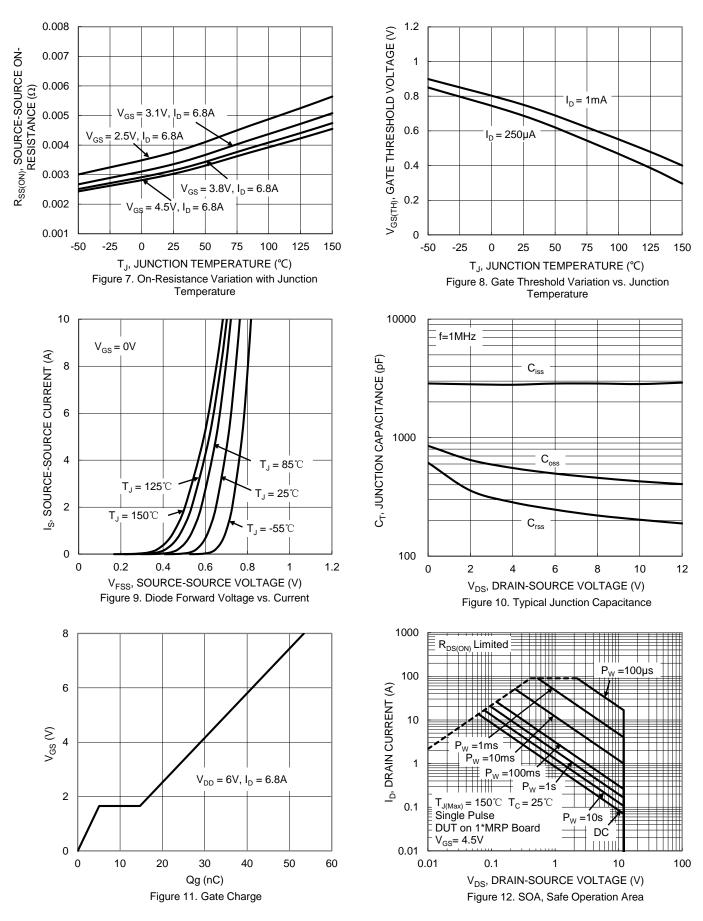


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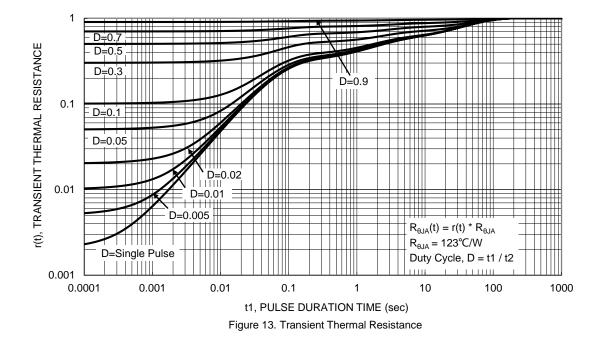
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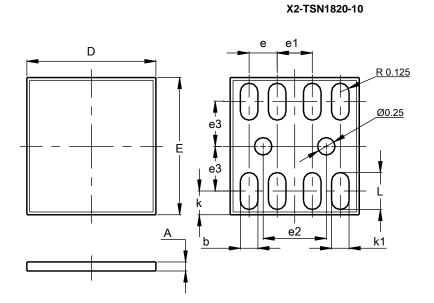






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

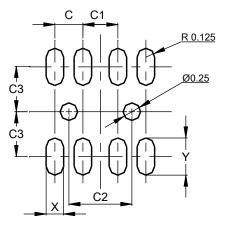


X2-TSN1820-10								
Dim	Min	Max	Тур					
Α	0.27	0.33	0.30					
b	0.22	0.28	0.25					
D	1.81	1.88	1.84					
Е	1.93	2.00	1.96					
е			0.40					
e1			0.50					
e2			0.90					
e3			0.64					
k			0.34					
k1			0.27					
L	0.50	0.56	0.53					
L1			1.81					
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)		
С	0.40		
C1	0.50		
C2	0.90		
C3	0.64		
X	0.25		
Y	0.53		



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